

August 2008

FDG327NZ

20V N-Channel PowerTrench^ò MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized use in small switching regulators, providing an extremely low $R_{\text{DS(ON)}}$ and gate charge (Q_{G}) in a small package.

Applications

- DC/DC converter
- Power management
- · Load switch



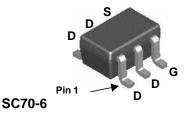
Features

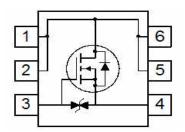
• 1.5 A, 20 V. $\begin{aligned} R_{DS(ON)} &= 90 \text{ m}\Omega \text{ @ V}_{GS} = 4.5 \text{ V.} \\ R_{DS(ON)} &= 100 \text{ m}\Omega \text{ @ V}_{GS} = 2.5 \text{ V.} \\ R_{DS(ON)} &= 140 \text{ m}\Omega \text{ @ V}_{GS} = 1.8 \text{ V.} \end{aligned}$

- . ,
- Low gate charge

· Fast switching speed

- High performance trench technology for extremely low $R_{\text{DS(ON)}}$
- · High power and current handling capability.





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	V
V_{GSS}	Gate-Source Voltage		± 8	
I _D	Drain Current - Continuous	(Note 1a)	1.5	Α
	- Pulsed		6	
P _D	Power Dissipation for Single Operation	(Note 1a)	0.42	W
		(Note 1b)	0.38	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	300	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	(Note 1b)	333	

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
.37	FDG327NZ	7"	8mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics	,		•		•
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = 250 \mu\text{A}$	20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		11		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μΑ
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			±10	μΑ
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.4	0.7	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	ID = 250 μA, Referenced to 25°C		-2		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{aligned} &V_{GS} = 4.5 \text{ V}, & I_{D} = 1.5 \text{ A} \\ &V_{GS} = 2.5 \text{ V}, & I_{D} = 1.4 \text{ A} \\ &V_{GS} = 1.8 \text{ V}, & I_{D} = 1.2 \text{ A} \\ &V_{GS} = 4.5 \text{ V}, &I_{D} = 1.5 \text{ A}, &T_{J} = 125 ^{\circ}\text{C} \end{aligned} $		68 77 90 86	90 100 140 123	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5V$, $V_{DS} = 5 V$	3			Α
g FS	Forward Transconductance	$V_{DS} = 10 \text{ V}, \qquad I_{D} = 1.5 \text{ A}$		2.2		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}$		412		pF
Coss	Output Capacitance	f = 1.0 MHz		81		pF
C _{rss}	Reverse Transfer Capacitance			44		pF
R_G	Gate Resistance	$V_{GS} = 15 \text{ mV}, f = 1.0 \text{ MHz}$		1.9		Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 10 \text{ V}, \qquad I_{D} = 1 \text{ A},$		6.2	13	ns
t _r	Turn-On Rise Time	$V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		2.3	10	ns
t _{d(off)}	Turn-Off Delay Time			18	33	ns
t _f	Turn-Off Fall Time			2.9	10	ns
Qg	Total Gate Charge	$V_{DS} = 10 \text{ V}, \qquad I_{D} = 1.5 \text{ A},$		4.2	6	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 \text{ V}$		0.4		nC
Q_{gd}	Gate-Drain Charge			1		nC
Drain-Sc	ource Diode Characteristics	and Maximum Ratings				
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 0.32 \text{ A} \text{(Note 2)}$		0.6	1.2	V
t _{rr}	Diode Reverse Recovery Time	$I_F = 1.5 \text{ A}, d_{iF}/d_t = 100 \text{ A/}\mu\text{s}$		4		nS
Q _{rr}	Diode Reverse Recovery Charge	1		2		nC

Notes

 R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{8JC} is guaranteed by design while R_{8CA} is determined by the user's board design.



a) 300°C/W when mounted on a 1in² pad of 2 oz copper.



o) 333°C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

Typical Characteristics

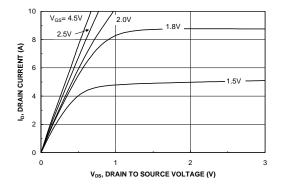


Figure 1. On-Region Characteristics.

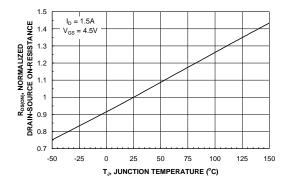


Figure 3. On-Resistance Variation withTemperature.

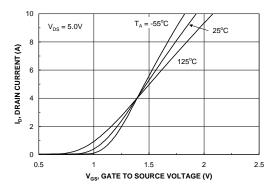


Figure 5. Transfer Characteristics.

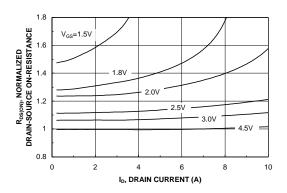


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

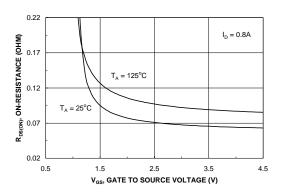


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

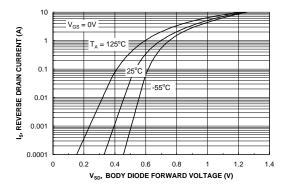
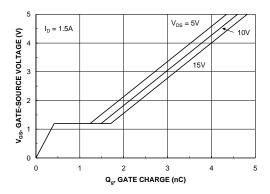


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics



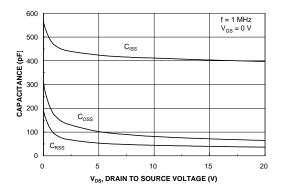


Figure 7. Gate Charge Characteristics.

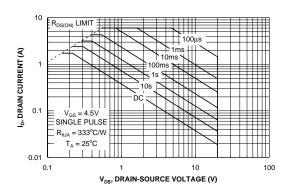


Figure 8. Capacitance Characteristics.

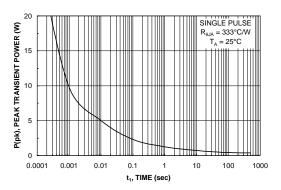


Figure 9. Maximum Safe Operating Area.



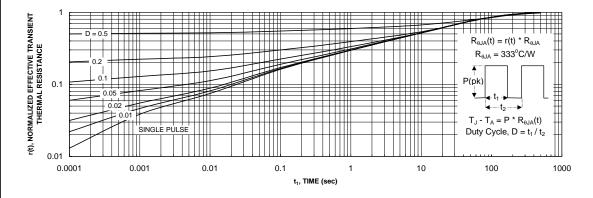


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidianries, and is not intended to be an exhaustive list of all such trademarks.

Build it Now™ CorePLUS™ CorePOWER™ $CROSSVOLT^{\text{TM}}$

CTL™ Current Transfer Logic™

EcoSPARK® EfficentMax™ EZSWITCH™ *

Fairchild®

Fairchild Semiconductor®

FACT Quiet Series™ FACT® FAST® FastvCore™ FlashWriter® *

FPS™ F-PFS™

Global Power ResourceSM

Green FPS™ Green FPS™ e-Series™

GTO™ IntelliMAX™ ISOPLANAR™

MegaBuck™ MICROCOUPLER™ MicroFFT™

MicroPak™ MillerDrive™ MotionMax™ Motion-SPM™

OPTOLOGIC® OPTOPLANAR® PDP SPM™ Power-SPM™ PowerTrench®

Programmable Active Droop™

QFET® QS™ Quiet Series™

RapidConfigure™ Saving our world, 1mW at a time™

SmartMax™ SMART START™

SPM®

STEALTH™ SuperFET™ SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS™ SyncFET™

SYSTEM ®

The Power Franchise®

P wer franchise TinyBoost™ TinyBuck™ TinyLogic[®] TINYOPTO™ TinyPower™ TinyPWM™ Tinẏ́Wire™

UHC® Ultra FRFET™

UniFFT™ VCX™ VisualMax™

* EZSWITCH™ and FlashWriter® are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Farichild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Farichild strongly encourages customers to purchase Farichild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Farichild is committed to committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS **Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 135

FDG327NZ Rev.C1(W)

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi

FDG327NZ_Q